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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/760,501	01/21/2004	Akira Nishiyama	247959US2TTCD	1483
22850	7590	06/14/2005	EXAMINER	
OBLON, SPIVAK, MCCLELLAND, MAIER & NEUSTADT, P.C. 1940 DUKE STREET ALEXANDRIA, VA 22314			WARREN, MATTHEW E	
			ART UNIT	PAPER NUMBER
			2815	

DATE MAILED: 06/14/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No. 10/760,501	Applicant(s) NISHIYAMA ET AL.	
	Examiner Matthew E. Warren	Art Unit 2815	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 24 March 2005.
- 2a) ☐ This action is FINAL. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-20 is/are pending in the application.
- 4a) Of the above claim(s) 15-20 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-14 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| Paper No(s)/Mail Date <u>1/21/04</u> | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

This Office Action is in response to the Election filed on March 24, 2005.

Election/Restrictions

Applicant's election without traverse of Group I, claims 1-14 in the reply filed on March 24, 2005 is acknowledged.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-3, 5, 7-10, 12, and 14 are rejected under 35 U.S.C. 102(e) as being anticipated by Horikawa (US Pub 2002/0135030 A1).

In re claim 1, Horikawa shows (fig. 1) a complementary field effect transistor comprising; a semiconductor substrate (2); an n-type field effect transistor (10) provided on the semiconductor substrate having: a first gate insulating film (14) containing an oxide (TiO₂, ZrO₂, or HfO₂) including an element selected from the group consisting group IV metals and Lanthanoid metals [0062-0063] (such as Ti, Zr, or Hf), and further

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containing a compound of the element and a group III element (such as Y or La) except aluminum; a first gate electrode (15) provided on the first gate insulating film; and n-type source and drain regions (12, 13) formed on both sides of the first gate electrode; and p-type field effect transistor (30) provided on the semiconductor substrate having: a second gate insulating film (34) containing an oxide (TiO_2 , ZrO_2 , or HfO_2) including an element selected from the group consisting group IV metals and Lanthanoid metals [0062-0063] (such as Ti, Zr, or Hf), and substantially containing none of group III element except aluminum; a second gate electrode (35) provided on the second gate insulating film; p-type source and drain regions (32, 33) provided on both sides of the second gate electrode.

In re claims 2 and 3, Horikawa discloses that [0057] a main component of the first gate electrode and a main component of the second gate electrode are the same and that the gate electrodes consist of one of Pt, Cu, Pd, Co, and W.

In re claim 5, Horikawa discloses [0078-0080] that the first gate insulating film includes positive charge.

In re claim 7, Horikawa discloses [0057] that the first gate electrode includes the group III element (Al).

In re claim 8, Horikawa et al. shows (fig. 1) a complementary field effect transistor comprising: semiconductor substrate (2); an n-type field effect transistor (10) provided on the semiconductor substrate having: a first gate insulating film (14) containing an oxide (TiO_2 , ZrO_2 , or HfO_2) including an element selected from the group

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consisting of group IV metals and Lanthanoid metals [0062-0063] (such as Ti, Zr, or Hf), and substantially containing none of group V elements and aluminum (aluminum is not required); a first gate electrode (15) provided on first gate insulating film; and n-type source and drain regions (12 and 13) formed on both sides of the first gate electrode; and a p-type field effect transistor (30) provided on the semiconductor substrate having: second gate insulating film (34) containing an oxide (TiO_2 , ZrO_2 , or HfO_2) including an element selected from the group consisting of group IV elements and Lanthanoid metals (such as Ti, Zr, or Hf), and further containing a compound of the element and a group V element or aluminum [0063] (such as Nb or Ta); a second gate electrode (35) provided on the second gate insulating film; and p-type source and drain regions (32, 33) provided on both sides of the second gate electrode.

In re claims 9 and 10, Horikawa discloses that [0057] a main component of the first gate electrode and a main component of the second gate electrode are the same and that the gate electrodes consist of one of Pt, Cu, Pd, Co, and W.

In re claim 12, Horikawa discloses [0078-0080] that the second gate insulating film includes negative charge.

In re claim 14, Horikawa discloses [0057] that the second gate electrode includes the group V element or aluminum.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

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(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 4, 6, 11, and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Horikawa (US Pub 2002/0135030 A1) as applied to claims 1, 5, 8, and 12 above, and further in view of Wallace et al. (US 6,020,243).

In re claims 4, 6, 11, and 13, Horikawa shows all of the elements of the claims except the concentration of the compound, the positive, or negative charge in the first or second gate insulating film is higher on side of the first gate electrode than on a side of the semiconductor substrate. Wallace et al. discloses (col. 2, lines 27-60) a high-k dielectric of zirconium or hafnium silicon oxynitride where most of the metal dopant is deposited in the upper surface of the oxide and near the gate electrode to employ primarily Si/SiO bonding at the silicon surface with resulting low interface state densities. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the gate insulating film of Horikawa by primarily doping the upper portions of the gate insulating film on the side of the gate electrode as taught by Wallace to form the gate insulating film having low interface state densities and good bonding with the substrate surface.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Tsunashima et al. (US 6,376,888 B1) and Morita et al. (US Pub.

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2004/0142579 A1) also show CMOS devices having gate insulating films comprising Lanthanoid metals and/or Group III, IV, and V elements.


Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew E. Warren whose telephone number is (571) 272-1737. The examiner can normally be reached on Mon-Thur and alternating Fri 9:00-5:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (571) 272-1664. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

MEW

June 8, 2005


TOM THOMAS
SUPERVISORY PATENT EXAMINER